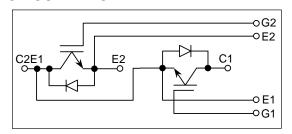
MBM200GR12A

[Rated 200A/1200V, Dual-pack type]

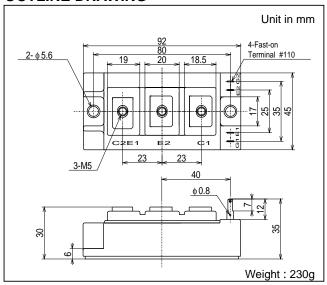
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to built-in free-wheeling diode.
 (<u>Ultra Soft and Fast recovery Diode (USFD)</u>)
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

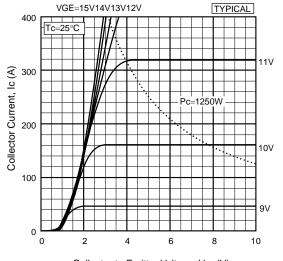
| ADOOLO IL III/A | MINION INATINGO | (10-20 0) | | | | |
|-----------------------------|-----------------|------------------|-----------|--------------------|--|--|
| Item | | Symbol | Unit | Value | | |
| Collector-Emitter Voltage | | V _{CES} | V | 1200 | | |
| Gate-Emitter Voltage | | V_{GES} | V | ±20 | | |
| Collector Current | DC | Ic | Α | 200 | | |
| | 1ms | I _{CP} | A | 400 | | |
| Forward Current | DC | I _F | ۸ | 200 *1 | | |
| | 1ms | I _{FM} | Α | 400 | | |
| Collector Power Dissipation | | Pc | W | 1250 | | |
| Junction Temperature | | Tj | °C | -40 ~ + 150 | | |
| Storage Temperature | | T _{stg} | °C | -40 ~ + 125 | | |
| Isolation Voltage | | V _{iso} | V_{RMS} | 2500(AC 1 minute) | | |
| Screw Torque | Terminals | | N⋅m | 1.96 | | |
| | Mounting | _ | INTIL | 1.96 *3 | | |

Notes; *1 : RMS current of diode ≤ 60 Arms *2 ,*3 : Recommended value 1.67 N·m

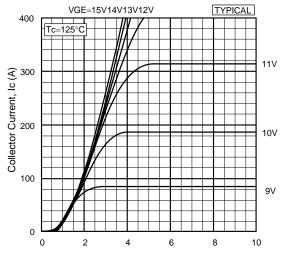
CHARACTERISTICS (T_C=25°C)

| CHARACTERISTICS (TC=25 C) | | | | | | | | | | |
|--------------------------------------|---------------|----------------------|------|------|-------|------|---|--|--|--|
| Item | | Symbol | Unit | Min. | Тур. | Max. | Test Conditions | | | |
| Collector-Emitter Cut-Off Current | | I _{CES} | mA | _ | _ | 1.0 | V _{CE} =1200V, V _{GE} =0V | | | |
| Gate-Emitter Leakage Current | | I _{GES} | nA | _ | _ | ±500 | $V_{GE}=\pm20V$, $V_{CE}=0V$ | | | |
| Collector-Emitter Saturation Voltage | | V _{CE(sat)} | V | _ | 2.2 | 2.8 | I _C =200A, V _{GE} =15V | | | |
| Gate-Emitter Threshold Voltage | | $V_{GE(TO)}$ | V | _ | _ | 10 | V _{CE} =5V, I _C =200mA | | | |
| Input Capacitance | | C _{ies} | pF | _ | 18000 | _ | V _{CE} =10V, V _{GE} =0V, f=1MHz | | | |
| Switching Times | Rise Time | t _r | μs | _ | 0.15 | 0.3 | V_{CC} =600V, I_{C} =200A R_{G} =6.2 Ω V_{GE} =±15V Inductive Load | | | |
| | Turn-On Time | ton | | _ | 0.3 | 0.6 | | | | |
| | Fall Time | t _f | | _ | 0.1 | 0.3 | | | | |
| | Turn-Off Time | t _{off} | | _ | 0.5 | 1.0 | | | | |
| Reverse Recovery Time | | t _{rr} | μS | _ | 0.2 | 0.4 | I _F =200A | | | |
| Peak Forward Voltage Drop | | V_{FM} | V | _ | 2.5 | 3.5 | I _F =200A, V _{GE} =0V | | | |
| Thermal Impedance | IGBT | R _{th(j-c)} | °C/W | _ | _ | 0.1 | Junction to case | | | |
| | FWD | R _{th(j-c)} | | | | 0.2 | | | | |

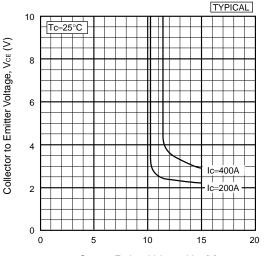
Notes; *4: R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted. Remark; For actual application, please confirm this spec. sheet is the newest revision.



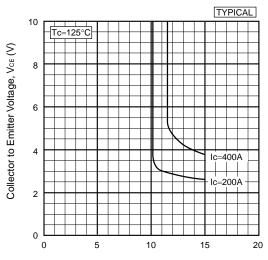
Collector to Emitter Voltage, Vce (V)
Collector current vs. Collector to Emitter voltage



Collector to Emitter Voltage, V_{CE} (V) Collector current vs. Collector to Emitter voltage

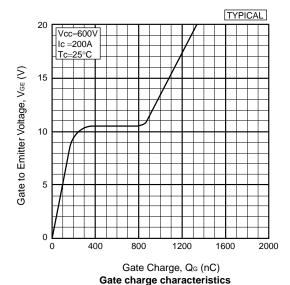


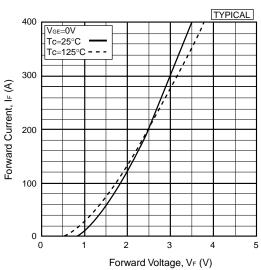
 $\label{eq:Gate to Emitter Voltage, VGE} Gate to Emitter voltage vs. Gate to Emitter voltage$



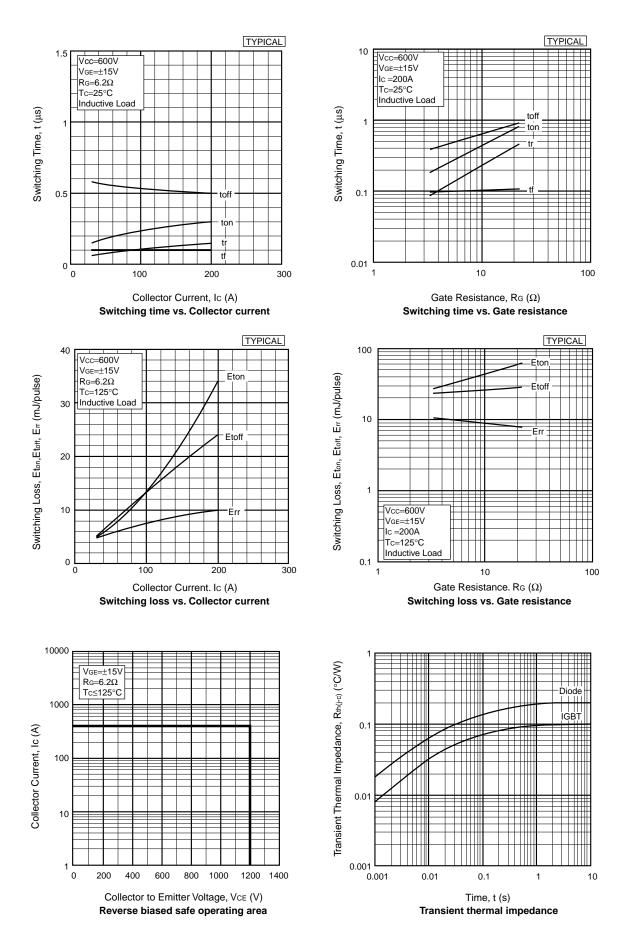
Gate to Emitter Voltage, V_{GE} (V)

Collector to Emitter voltage vs. Gate to Emitter voltage





Forward voltage of free-wheeling diode



HITACHI POWER SEMICONDUCTORS

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